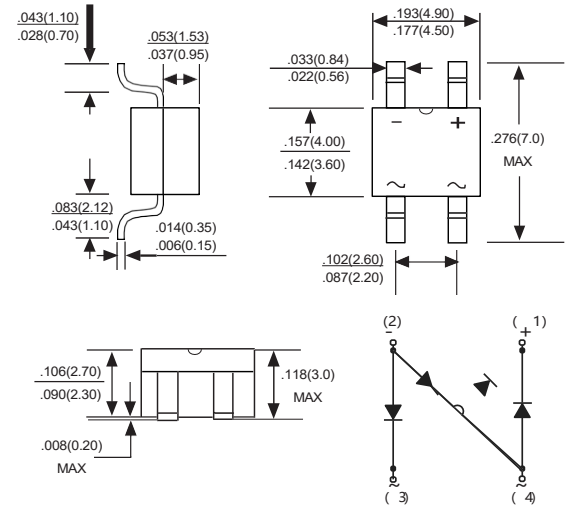


GLASS PASSIVATED SUPER FAST RECOVERY BRIDGE RECTIFIERS

Features

- ◆ Ideal for printed circuit board
- ◆ Reliable low cost construction utilizing molded plastic technique
- ◆ High temperature soldering guaranteed: 260°/10 seconds at 5 lbs., (2.3kg) tension
- ◆ Small size, simple installation
- ◆ High surge current capability
- ◆ Glass passivated chip junction

MBS



Dimensions in inches and (millimeters)

Maximum Ratings And Electrical Characteristics

Ratings at 25°C ambient temperature unless otherwise specified.

Single phase half-wave 60Hz, resistive or inductive load, for capacitive load current derate by 20%.

Parameter	SYMBOLS	EMB2S	EMB4S	EMB6S	EMB8S	UNITS
Marking Code						
Maximum repetitive peak reverse voltage	V _{RRM}	100	200	400	600	V
Maximum RMS voltage	V _{RMS}	70	140	280	420	V
Maximum DC blocking voltage	V _{DC}	100	200	400	600	V
Maximum average forward rectified current On glass-epoxy P.C.B.(Note1) On aluminum substrate(Note2)	I _{F(AV)}	0.5 0.8				A
Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)	I _{FSM}	30				A
Maximum instantaneous forward voltage drop per leg at 0.4A	V _F	0.95		1.25	1.7	V
Maximum DC reverse current T _A =25°C at rated DC blocking voltage T _A =100°C	I _R	5 0.5				uA mA
Typical thermal resistance(NOTE 3)	RθJL	28				°C/W
	RθJA	85				
Maximum reverse recovery time (NOTE 4)	trr	35				ns
Operating temperature range	T _J	-55 to +150				°C
storage temperature range	T _{STG}	-55 to +150				°C

NOTES: 1. On glass epoxy P.C.B. mounted on 0.05x0.05"(1.3x1.3mm) pads.

2. On aluminum substrate P.C.B. with an area of 0.8"x0.8"(20x20mm) mounted on 0.05X0.05"(1.3X1.3mm) solder pad.

3. Thermal resistance from junction to ambient and junction to lead mounted on P.C.B. with 0.2X0.2"(5X5mm) copper pads.

4. Reverse recovery condition $I_F=0.5A, I_R=1.0A, I_{rr}=0.25A$.

Ratings And Characteristic Curves

FIG.1 FORWARD DERATING CURVE

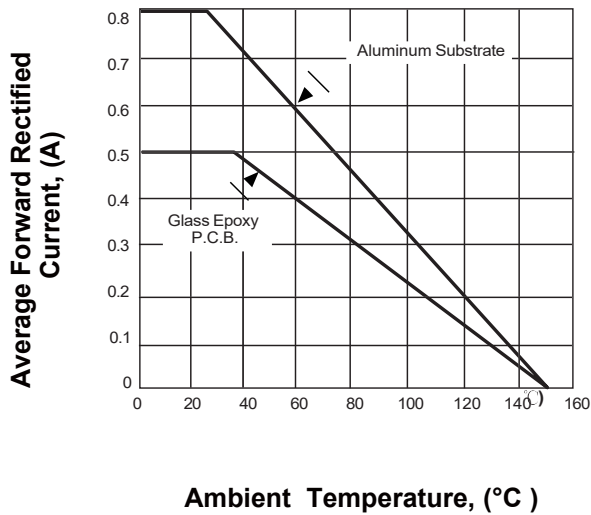


FIG.2 PEAK FORWARD SURGE CURRENT

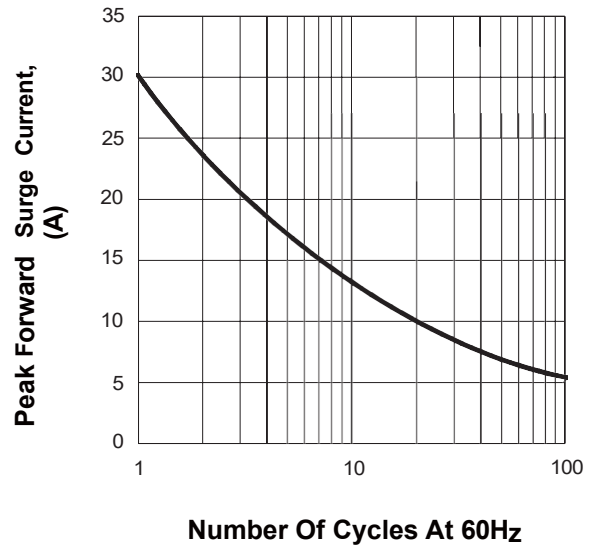


FIG.3 TYPICAL FORWARD CHARACTERISTICS

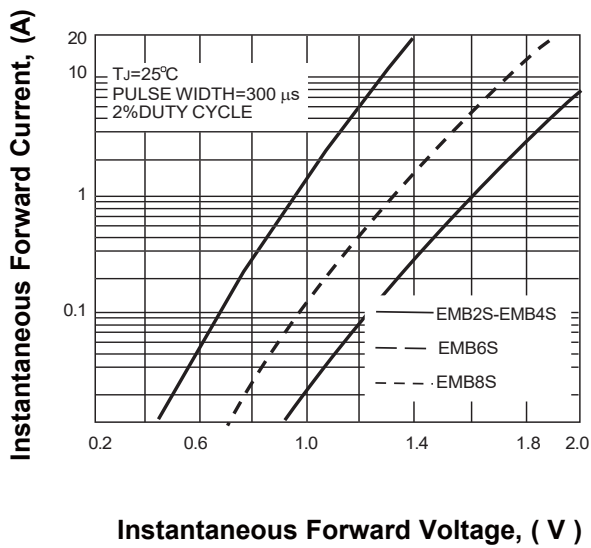
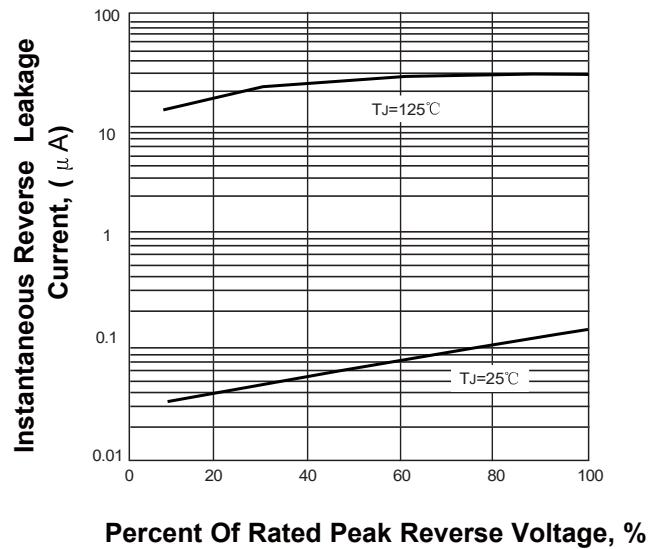
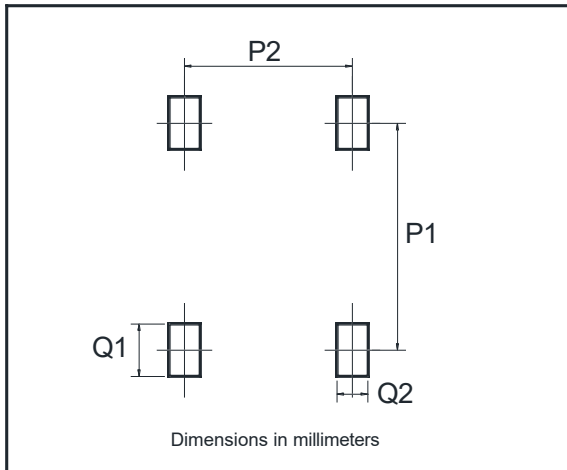


FIG.4 TYPICAL REVERSE CHARACTERISTICS



The curve above is for reference only.

Suggested Pad Layout



Dim	Min
P1	6.00
P2	2.40
Q1	1.84
Q2	1.20